

N-Channel 700V (D-S) Super Junction Power MOSFET

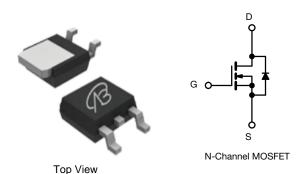
PRODUCT SUMMARY				
V _{DS} (V) at T _J max.	700			
R _{DS(on)} typ. (Ω) at 25 °C	V _{GS} = 10 V	0.560		

FEATURES

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (Ciss)
- Reduced switching and conduction losses
- Ultra low gate charge (Qg)
- Avalanche energy rated (UIS)



TO-252



APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
- Battery chargers
- Renewable energy
- Solar (PV inverters)

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V_{DS}	700	V	
Gate-source voltage			V_{GS}	± 30	V	
Continuous drain current (T. – 150 °C)	V at 10 V	$T_C = 25 ^{\circ}C$ $T_C = 100 ^{\circ}C$	_	8		
Continuous drain current (T _J = 150 °C)	V _{GS} at 10 V	T _C = 100 °C	I _D	5	Α	
Pulsed drain current ^a			I _{DM}	24		
Linear derating factor				1.7	W/°C	
Single pulse avalanche energy b			E _{AS}	330	mJ	
Maximum power dissipation			P_{D}	180	W	
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C	
Drain-source voltage slope $T_J = 125 ^{\circ}\text{C}$		dV/dt	50	V/ns		
Reverse diode dV/dt ^d			5.1	V/IIS		
Soldering recommendations (peak temperature) c For 10 s			260	°C		

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b. V_{DD} = 100 V, starting T_J = 25 °C, L = 30 mH, R_g = 25 Ω , I_{AS} = 4A
- c. 1.6 mm from case
- d. $I_{SD} \le I_D$, $dI/dt = 100 \text{ A/}\mu\text{s}$, starting $T_J = 25 \,^{\circ}\text{C}$

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THERMAL RESISTANCE RATINGS						
PARAMETER	SYMBOL	TYP.	MAX.	UNIT		
Maximum junction-to-ambient	R _{thJA}	=	62	°C/W		
Maximum junction-to-case (drain)	R _{thJC}	-	0.85	G/ VV		

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static				•			
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		700	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D = 1 mA	-	1.08	1	V/°C
Gate-source threshold Voltage (N)	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \ \mu A$		2.0	-	4.0	V
	. ` `	$V_{GS} = \pm 20 \text{ V}$		-	-	± 100	nA
Gate-source leakage	I _{GSS}		V _{GS} = ± 30 V		-	± 1	μΑ
	_	V _{DS} =	V _{DS} = 700 V, V _{GS} = 0 V		-	1	
Zero gate voltage drain current	I _{DSS}	V _{DS} = 560 \	/, V _{GS} = 0 V, T _J = 125 °C	-	-	10	μA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	I _D =6A	-	0.560	-	Ω
Forward transconductance	9 _{fs}		= 30 V, I _D = 5 A	-	8.7	-	S
Dynamic	<u> </u>			1			<u> </u>
Input capacitance	C _{iss}		V _{GS} = 0 V,	_	2300	_	
Output capacitance	C _{oss}	1	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$	_	51	-	
Reverse transfer capacitance	C _{rss}	1	f = 1 MHz		12	-	-
Effective output capacitance, energy		V _{DS} = 0 V to 480 V, V _{GS} = 0 V		-			pF
related ^a	C _{o(er)}			-	48	ı	
Effective output capacitance, time related ^b	$C_{o(tr)}$			-	205	-	
Total gate charge	Qg		V _{GS} = 10 V I _D = 5 A, V _{DS} = 480 V		25	-	nC
Gate-source charge	Q _{gs}	$V_{GS} = 10 \text{ V}$			8	-	
Gate-drain charge	Q _{gd}	1			10	-	
Turn-on delay time	t _{d(on)}			-	12	24	- ns
Rise time	t _r	Van	$V_{DD} = 480 \text{ V}, I_D = 5 \text{ A},$		14	23	
Turn-off delay time	t _{d(off)}	$V_{DD} = 480 \text{ V}, I_D = 3 \text{ A},$ $V_{GS} = 10 \text{ V}, R_a = 9.1 \Omega$		-	61	110	
Fall time	t _f		. Go , g		16	1	
Gate input resistance	R_g	f = 1 MHz, open drain		0.3	0.7	1.4	Ω
Drain-Source Body Diode Characteristic	s	-					
Continuous source-drain diode current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	8	
Pulsed diode forward current	I _{SM}			-	-	24	A
Diode forward voltage	V _{SD}	T _J = 25 °C, I _S = 5 A, V _{GS} = 0 V		-	-	1.2	V
Reverse recovery time	t _{rr}	$T_J = 25 \text{ °C}, I_F = I_S = 5 \text{ A},$ $dI/dt = 100 \text{ A/}\mu\text{s}, V_R = 25 \text{ V}$		-	55	110	ns
Reverse recovery charge	Q _{rr}			-	6.4	12.8	μC
Reverse recovery current	I _{RRM}			_	27	_	A

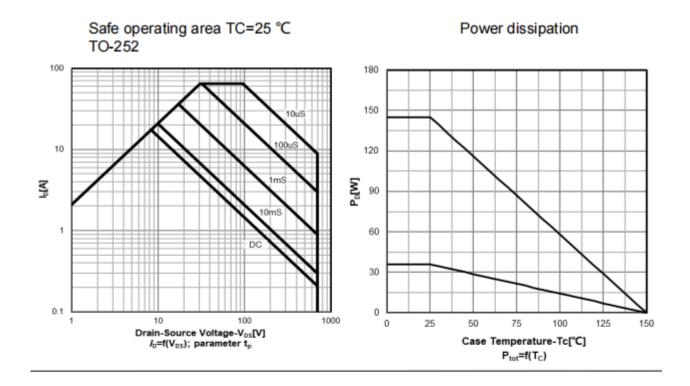
Notes

- a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}

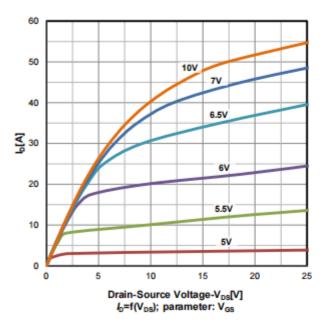
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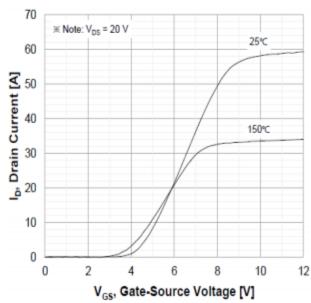
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Typ. output characteristics T_i =25 $^{\circ}C$



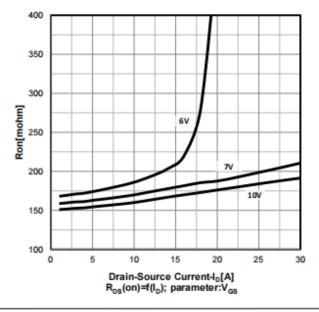
Transfer characteristics



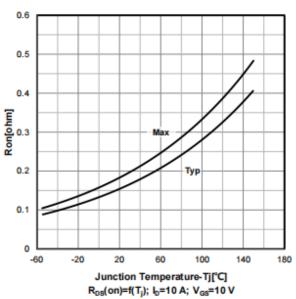
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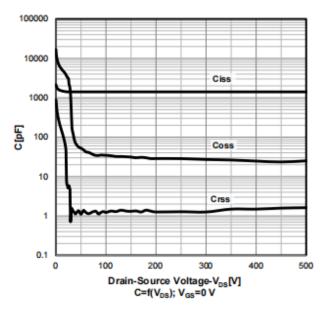
Typ. drain-source on-state resistance



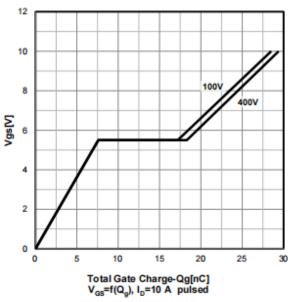
On-resistance vs temperature



Typ. capacitances



Typ. gate charge characteristics

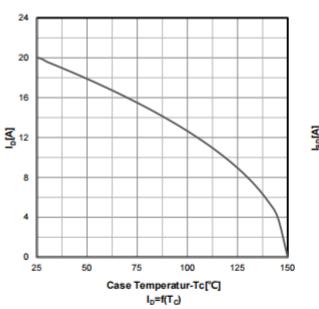


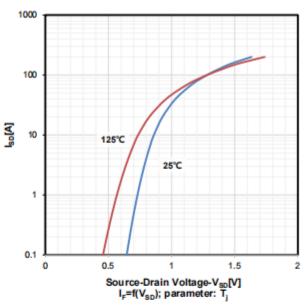
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Drain current vs temperature

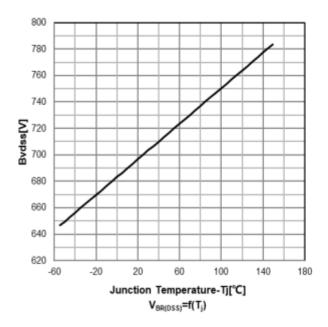
Forward characteristics of reverse diode

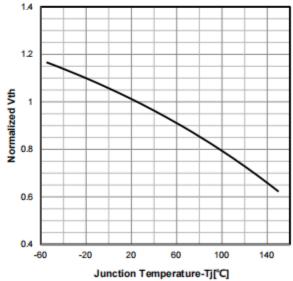




Drain-source breakdown voltage

Normalized $V_{\text{GS}(\text{th})}$ characteristics

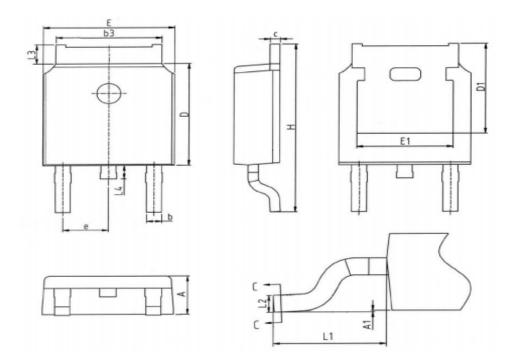




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Package Outline: TO 252



COMMON DIMENSIONS

SYMBOL	UNIT(mm)				
STMBOL	MIN	NOM	MAX		
A	2.20	2.30	2.40		
A1	0.00	-	0.127		
b	0.66	0.78	0.90		
b3	5.16	5.31	5.46		
c	0.43	0.53	0.63		
D	5.98	6.10	6.22		
D1	5.30REF				
E	6.40	6.60	6.75		
E1	4.63	-	-		
e	2.286BSC				
H	9.40	10.10	10.50		
L1	2.90REF				
L2	0.51BSC				
L3	0.88	1.08	1.28		
L4	0.50	0.80	1.00		

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DMN2080UCB4-7 DMN61D9UWQ-13 US6M2GTR DMN31D5UDJ-7 DMP22D4UFO-7B DMN1006UCA6-7 DMN16M9UCA6-7
STF5N65M6 IRF40H233XTMA1 STU5N65M6 DMN6022SSD-13 DMN13M9UCA6-7 DMTH10H4M6SPS-13 DMN2990UFB-7B
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